PRODUCT / PROCESS CHANGE NOTIFICATION

| 1. PCN basic data | | |
|---|--|---|
| 1.1 Company STMicroelectronics International N.V | | STMicroelectronics International N.V |
| 1.2 PCN No. | | MDG/20/12190 |
| 1.3 Title of PCN | | ASE Kaohsiung (Taiwan) additional source for TFBGA14x14 for STM32H75 2MB products |
| 1.4 Product Category | | TFBGA14x14 for STM32H75 2MB products |
| 1.5 Issue date | | 2020-09-11 |

| 2. PCN Team | | |
|---------------------------|----------------------------|--|
| 2.1 Contact supplier | | |
| 2.1.1 Name | ROBERTSON HEATHER | |
| 2.1.2 Phone | +1 8475853058 | |
| 2.1.3 Email | heather.robertson@st.com | |
| 2.2 Change responsibility | | |
| 2.2.1 Product Manager | Ricardo Antonio DE SA EARP | |
| 2.1.2 Marketing Manager | Veronique BARLATIER | |
| 2.1.3 Quality Manager | Pascal NARCHE | |

| 3. Change | | | |
|--------------|---|----------------------------|--|
| 3.1 Category | 3.2 Type of change | 3.3 Manufacturing Location | |
| | Line transfer for a full process or process brick (process step, control plan, recipes) from one site to another site: Assembly site (SOP 2617) | ASE Kaohsiung Taiwan | |

| 4. Description of change | | | |
|---|--|---|--|
| | Old | New | |
| 4.1 Description | Back-end sources: - Amkor ATP Philippines | Back-end sources: - Amkor ATP Philippines - ASE Kaohsiung Taiwan - Additional source For more information, please refer to PCN12190 – Additional information attached document. | |
| 4.2 Anticipated Impact on form,fit, function, quality, reliability or processability? | Different manufacturing site Molding compound impacting Package darkness (color) Ball material and Package Outline Assembly (POA) dimensions changes. No other change in spec. | | |

| 5. Reason / motivation for change | | |
|-----------------------------------|--|--|
| | Due to the success on the market of STM32 devices, ST Microcontrollers Division decided to qualify an additional back-end site to maintain state of the art service level to our customers thanks to extra capacity. | |
| 5.2 Customer Benefit | CAPACITY INCREASE | |

| 6. Marking of parts / traceability of change | | |
|--|--|--|
| 6.1 Description | Tracability is ensure by ST internal tools. Please refer to PCN12190 Additional information attached document. | |

| 7. Timing / schedule | | |
|-------------------------------------|--------------|--|
| 7.1 Date of qualification results | 2020-10-30 | |
| 7.2 Intended start of delivery | 2020-10-30 | |
| 7.3 Qualification sample available? | Upon Request | |

| 8. Qualification / Validation | | |
|-------------------------------|---|--|
| | 12190 MDG-MCD-RERMCD2011 PCN12190 - ASE Kaohsiung additional source for TFBGA 14x14 STM32- reliability plan.pdf | |

| | Available (see attachment) | Issue | 2020-09-11 |
|-----------------------|----------------------------|-------|------------|
| qualification results | | Date | |

9. Attachments (additional documentations)

12190 Public product.pdf
12190 MDG-MCD-RERMCD2011 PCN12190 - ASE Kaohsiung additional source for TFBGA 14x14 STM32- reliability plan.pdf
12190 PCN12190_Additional information.pdf

| 10. Affected parts | | | |
|-------------------------|-------------------------|--------------------------|--|
| 10. 1 Current | | 10.2 New (if applicable) | |
| 10.1.1 Customer Part No | 10.1.2 Supplier Part No | 10.1.2 Supplier Part No | |
| | STM32H743XIH6 | | |
| | STM32H745XIH6 | | |
| | STM32H747XIH6 | | |
| | STM32H750XBH6 | | |
| | STM32H753XIH6 | | |
| | STM32H757XIH6 | | |



Public Products List

Publict Products are off the shelf products. They are not dedicated to specific customers, they are available through ST Sales team, or Distributors, and visible on ST.com

PCN Title: ASE Kaohsiung (Taiwan) additional source for TFBGA14x14 for STM32H75 2MB products

PCN Reference: MDG/20/12190

Subject: Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change.

| STM32H747XIH6 | STM32H755XIH3 | |
|---------------|---------------|---------------|
| STM32H743XGH6 | STM32H742XIH6 | STM32H757XIH6 |
| STM32H753XIH6 | STM32H742XGH6 | STM32H755XIH6 |
| STM32H745XIH3 | STM32H747XGH6 | STM32H745XIH6 |
| STM32H743XIH6 | STM32H745XGH6 | STM32H750XBH6 |

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